

X3-Class HiPerFET™ **Power MOSFET**

IXFK210N30X3 IXFX210N30X3

300V 210A $5.5 m\Omega$

N-Channel Enhancement Mode Avalanche Rated

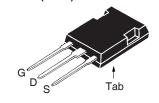


Symbol	Test Conditions	Maximum Ra	atings
V _{DSS}	T _J = 25°C to 150°C	300	V
V _{DGR}	$T_J = 25^{\circ}C$ to 150°C, $R_{GS} = 1M\Omega$	300	V
V _{gss}	Continuous	±20	V
V _{GSM}	Transient	±30	V
I _{D25}	T _C = 25°C	210	A
I _{L(RMS)}	External Lead Current Limit	160	Α
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	650	Α
I _A	T _C = 25°C	105	А
E _{AS}	$T_{c} = 25^{\circ}C$	3	J
dv/dt	$I_{_{\mathrm{S}}} \leq I_{_{\mathrm{DM}}}, \ V_{_{\mathrm{DD}}} \leq V_{_{\mathrm{DSS}}}, \ T_{_{\mathrm{J}}} \leq 150^{\circ}\mathrm{C}$	20	V/ns
P_{D}	T _c = 25°C	1250	W
T _J		-55 +150	°C
T _{JM}		150	°C
T _{stg}		-55 + 150	°C
T _L	Maximum Lead Temperature for Soldering	300	°C
T _{SOLD}	1.6 mm (0.062in.) from Case for 10s	260	°C
M _d	Mounting Torque (TO-264)	1.13/10	Nm/lb.in
F _c	Mounting Force (PLUS247)	20120 /4.527	N/lb
Weight	TO-264 PLUS247	10 6	g g

Symbol (T _J = 25°C,	Test Conditions Unless Otherwise Specified)	Charac Min.	cteristic Typ.	Values Ma	
BV _{DSS}	$V_{GS} = 0V, I_{D} = 3mA$	300			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 8mA$	2.5		4.5	V
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±200	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			25 2.5	μA mA
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.5 \bullet I_{D25}, Note 1$		4.3	5.5	mΩ



PLUS247 (IXFX)



G = Gate D = Drain Tab = Drain S = Source

Features

- International Standard Packages
- Low $R_{DS(ON)}$ and Q_G Avalanche Rated
- Low Package Inductance

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode **Power Supplies**
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls



Symbol Test Conditions Chara		acteristic Values		
$(T_{J} = 25^{\circ}C, V)$	Unless Otherwise Specified)	Min.	Тур.	Max
g _{fs}	$V_{DS} = 10V, I_{D} = 60A, Note 1$	84	140	S
R_{Gi}	Gate Input Resistance		2	Ω
C _{iss}			24.2	nF
Coss	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		3.1	nF
C _{rss}			7.7	pF
	Effective Output Capacitance			
$C_{o(er)}$	Energy related $\int_{GS} V_{GS} = 0V$		1100	pF
$C_{o(tr)}$	Time related $\int V_{DS}^{GS} = 0.8 \cdot V_{DSS}$		4600	pF
t _{d(on)}	Resistive Switching Times		38	ns
t,	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		40	ns
t _{d(off)}	$R_{c} = 1\Omega$ (External)		210	ns
t _f	II _G = 132 (External)		15	ns
$Q_{g(on)}$			375	nC
Q _{gs}	$V_{gs} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		107	nC
Q _{gd}			100	nC
R _{thJC}				0.10 °C/W
R _{thCS}			0.15	°C/W

Source-Drain Diode

Symbol	Test Conditions	Characteristic Values			
$(T_{J} = 25^{\circ}C, l)$	Jnless Otherwise Specified)	Min.	Тур.	Max	
I _s	$V_{GS} = 0V$			210	Α
I _{SM}	Repetitive, pulse Width Limited by $T_{_{JM}}$			840	Α
V _{SD}	$I_F = 100A, V_{GS} = 0V, Note 1$			1.4	V
$\left\{ egin{array}{c} \mathbf{t}_{rr} \\ \mathbf{Q}_{RM} \\ \mathbf{I}_{RM} \end{array} \right\}$	$I_F = 105A$, $-di/dt = 100A/\mu s$ $V_R = 100V$		190 1.4 15		ns µC A

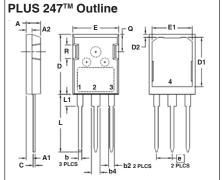
Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

Terminals: 1 = Gate 2.4 = Drain 3 = Source

SYM	INCHES		MILLIMETERS	
21M	MIN	MAX	MIN	MAX
A	.185	.209	4.70	5.30
A1	.102	.118	2.60	3.00
b	.035	.049	0.90	1.25
b1	.091	.106	2.30	2.70
b2	.110	.126	2.80	3.20
С	.020	.033	0.50	0.85
D	1.012	1.035	25.70	26.30
E	.776	.799	19.70	20.30
е	.215BSC		5.46 BSC	
L	.768	.807	19.50	20.50
L1	.091	.106	2.30	2.70
ØΡ	.122	.138	3.10	3.50
Q	.228	.244	5.80	6.20
Q1	.346	.362	8.80	9.20
ØR	.150	.165	3.80	4.20
ØR1	.071	.087	1.80	2.20
S	.228	.244	5.80	6.20

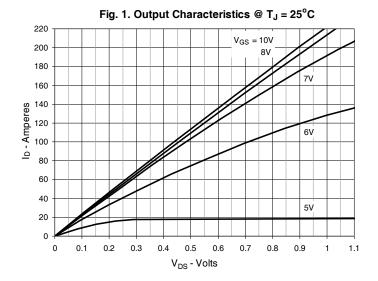


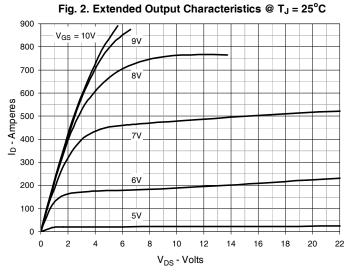
Terminals: 1 - Gate 2,4 - Drain 3 - Source

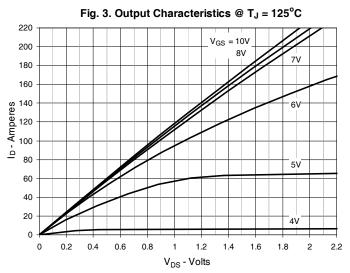
SYM	INCH	INCHES MILLIMET		1ETERS
21M	MIN	MAX	MIN	MAX
Α	.190	.205	4.83	5.21
A1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
Ь	.045	.055	1.14	1.40
b2	.075	.087	1.91	2.20
b4	.115	.126	2,92	3.20
С	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
D1	.650	.690	16.51	17.53
D2	.035	.050	0.89	1.27
Ε	.620	.635	15.75	16.13
E1	.520	.560	13.08	14.22
е	.215	BSC	5.45 BSC	
L	.780	.810	19.81	20.57
L1	.150	.170	3.81	4,32
Q	.220	.244	5.59	6.20
R	.170	.190	4.32	4.83

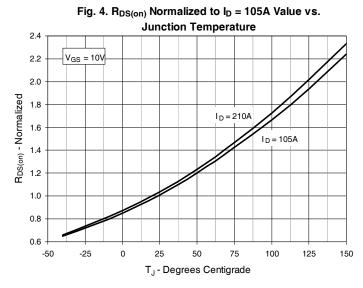
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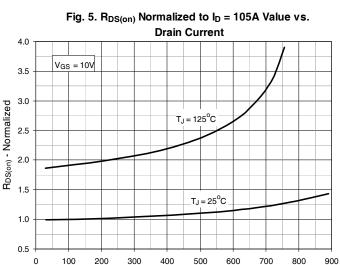












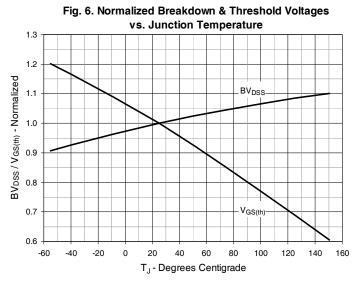
400

I_D - Amperes

500

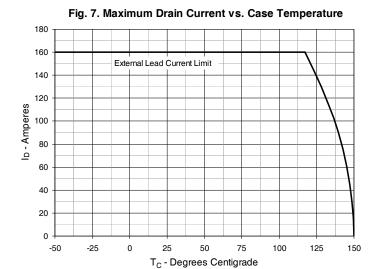
700

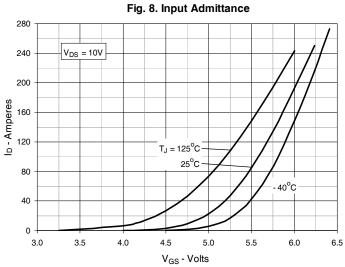
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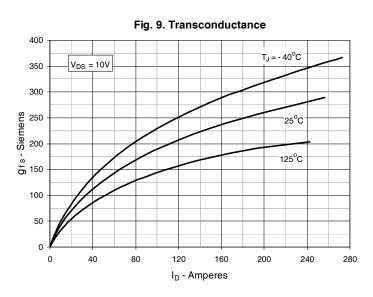


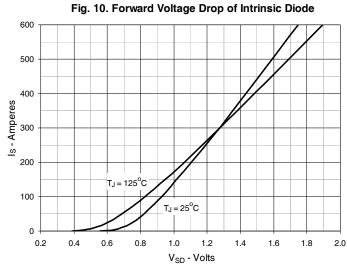
200

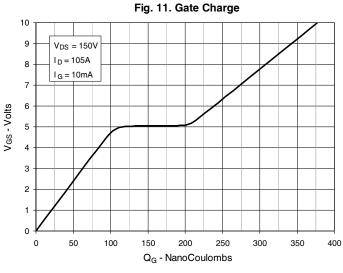


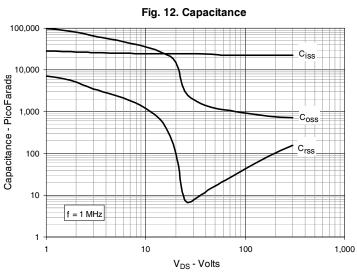






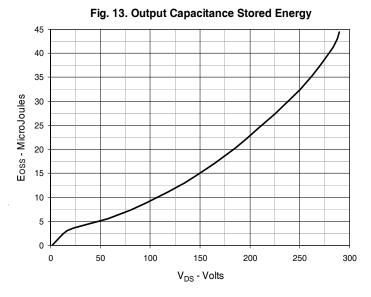






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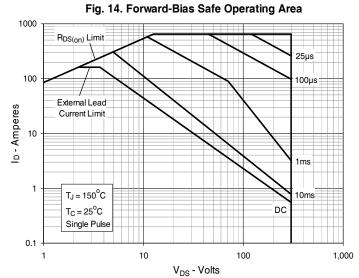


Fig. 15. Maximum Transient Thermal Impedance

